



Group Art Unit 2818

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent application of

Takaaki Sasaki :

Serial No. 09/689,824 : Examiner Renee R. Berry

Filed October 13, 2000

SEMICONDUCTOR DEVICE, SEMICONDUCTOR PACKAGE FOR USE THEREIN, AND MANUFACTURING METHOD THEREOF

SUPPLEMENTAL AMENDMENT

Honorable Commissioner For Patents Washington, D.C. 20231

Sir:

Supplemental to the Amendment filed March 21, 2002, the following

additional amendments and remarks are submitted:

REQEIVED

MAY 23 2002

TC 2800 MAIL ROOI

In the Claims¹

Kindly rewrite Claim 7 to read as follows:

7. (Twice amended) A method of manufacturing a semiconductor device with a semiconductor element fixed to a semiconductor package, comprising the steps of:

¹ A copy of any revised claims showing additions and deletions thereto is attached as ATTACHMENT "A".